



2SA1768 — PNP Epitaxial Planar Silicon Transistor

High-Voltage Switching Applications

Applications

- Color TV sound output, converter, inverter

Features

- Adoption of MBIT process
- High breakdown voltage, large current capacity
- Fast switching speed

Specifications

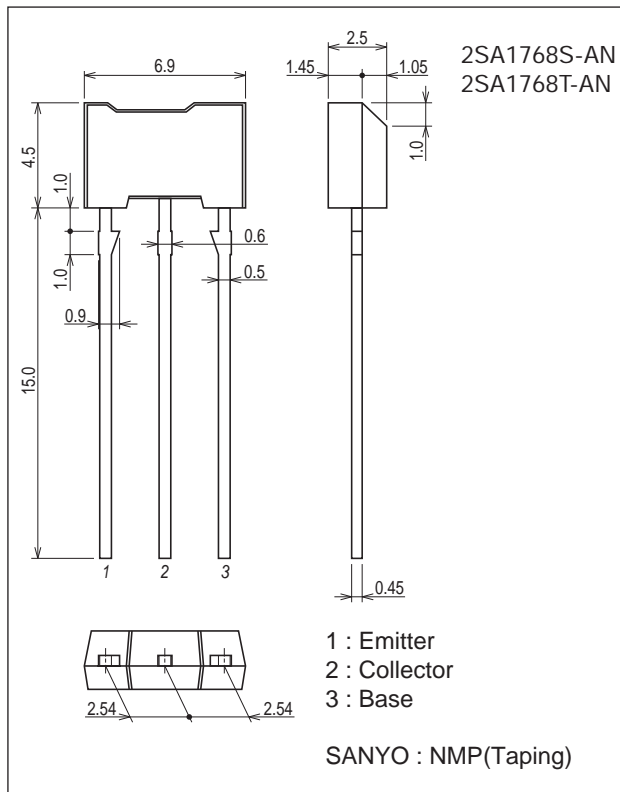
Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Collector-to-Base Voltage	VCBO		-180	V
Collector-to-Emitter Voltage	VCEO		-160	V
Emitter-to-Base Voltage	VEBO		-6	V
Collector Current	IC		-0.7	A
Collector Current (Pulse)	ICP		-1.5	A
Collector Dissipation	PC		1	W
Junction Temperature	Tj		150	°C
Storage Temperature	Tstg		-55 to +150	°C

Package Dimensions

unit : mm (typ)

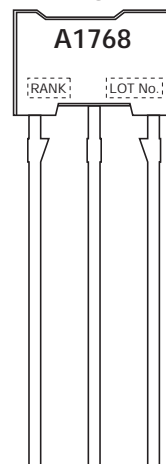
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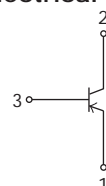
Product & Package Information

- Package : NMP(Taping)
- JEITA, JEDEC : SC-71
- Minimum Packing Quantity : 2,500 pcs./box

Marking(NMP(Taping))



Electrical Connection



2SA1768

Electrical Characteristics at Ta=25°C

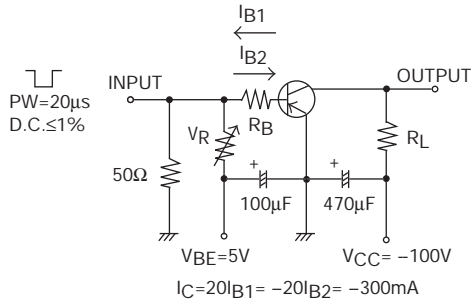
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Collector Cutoff Current	I_{CBO}	$V_{CB}=-120V, I_E=0A$			-0.1	μA
Emitter Cutoff Current	I_{EBO}	$V_{EB}=-4V, I_C=0A$			-0.1	μA
DC Current Gain	h_{FE1}	$V_{CE}=-5V, I_C=-100mA$	140*		400*	
	h_{FE2}	$V_{CE}=-5V, I_C=-10mA$	90			
Gain-Bandwidth Product	f_T	$V_{CE}=-10V, I_C=-50mA$		120		MHz
Output Capacitance	C_{ob}	$V_{CB}=-10V, f=1MHz$		11		pF
Collector-to-Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C=-250mA, I_B=-25mA$		-0.2	-0.5	V
Base-to-Emitter Saturation Voltage	$V_{BE(sat)}$			-0.85	-1.2	V
Collector-to-Base Breakdown Voltage	$V_{(BR)CBO}$	$I_C=-10\mu A, I_E=0A$	-180			V
Collector-to-Emitter Breakdown Voltage	$V_{(BR)CEO}$	$I_C=-1mA, R_{BE}=\infty$	-160			V
Emitter-to-Base Breakdown Voltage	$V_{(BR)EBO}$	$I_E=-10\mu A, I_C=0A$	-6			V
Turn-ON Time	t_{on}	See specified Test Circuit.		60		ns
Storage Time	t_{stg}			900		ns
Fall Time	t_f			60		ns

* : The 2SA1768 is classified by 100mA h_{FE} as follows :

Rank	S	T
h_{FE}	140 to 280	200 to 400

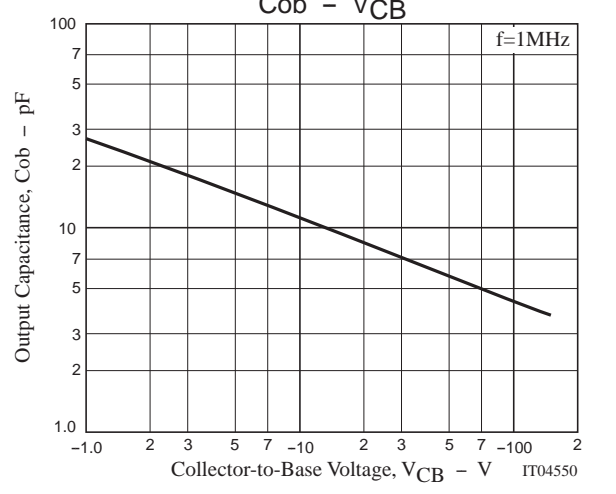
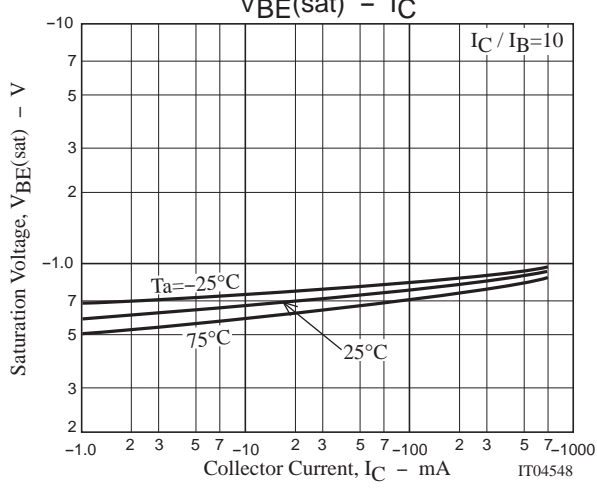
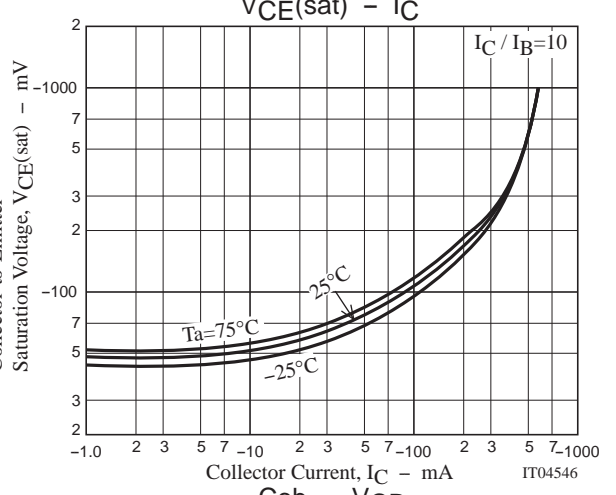
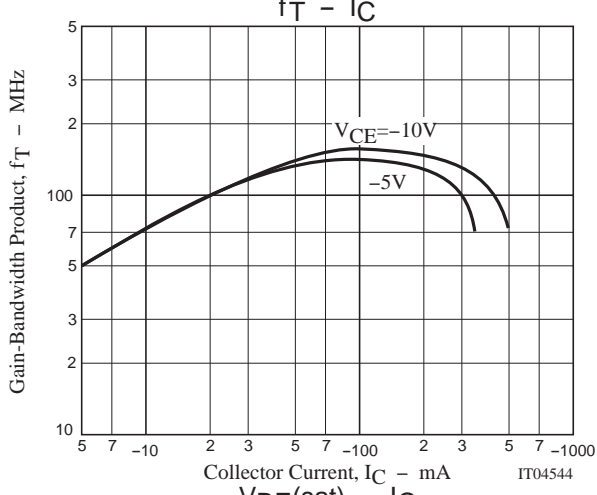
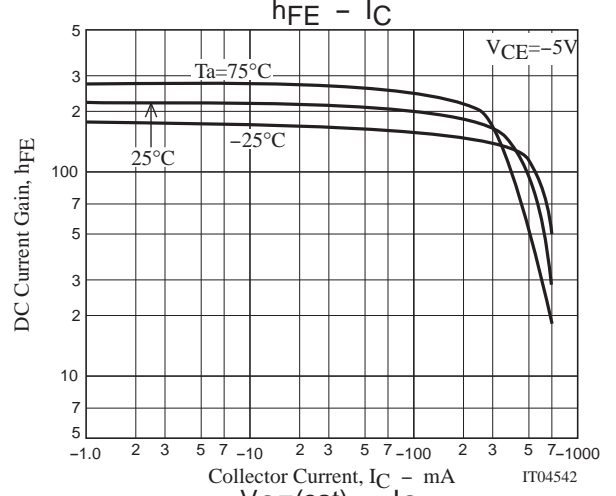
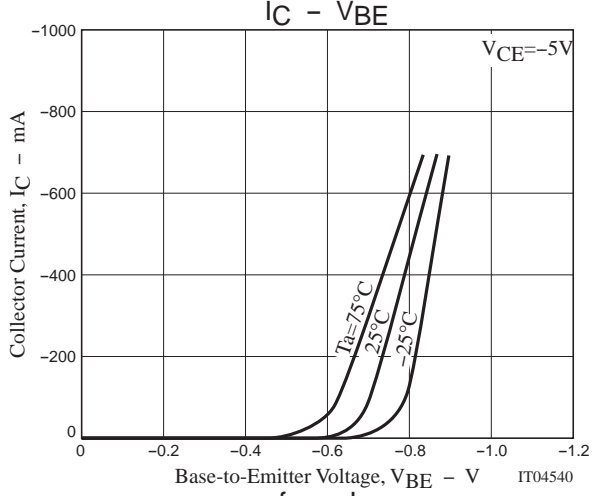
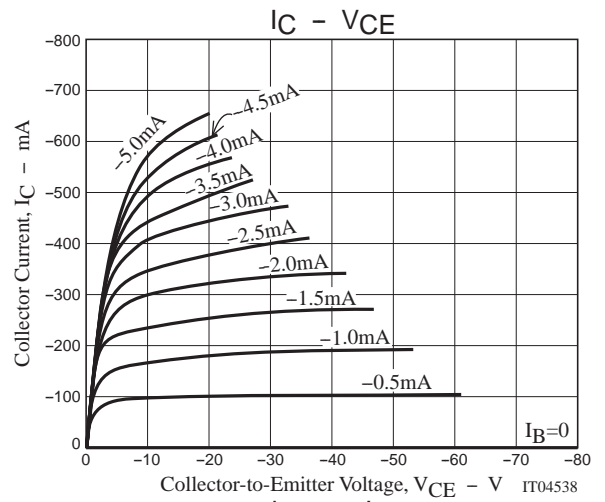
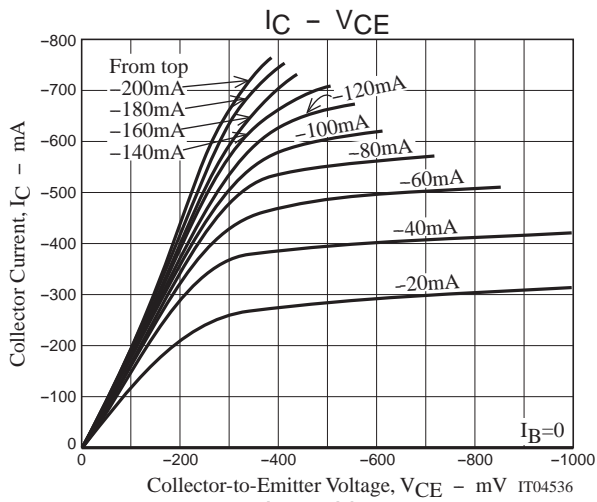
Switching Time Test Circuit

2SA1768

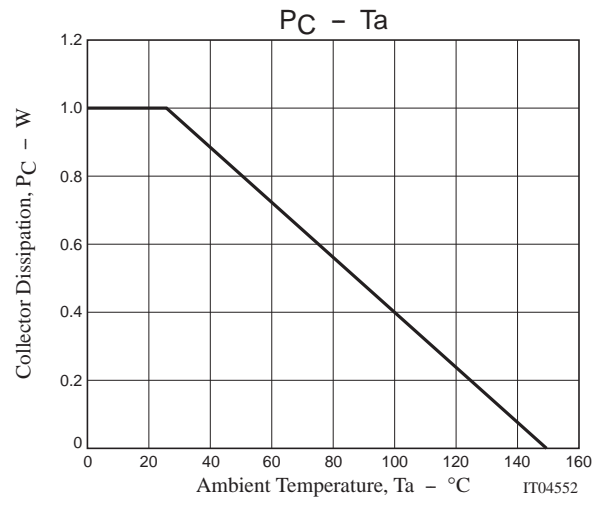
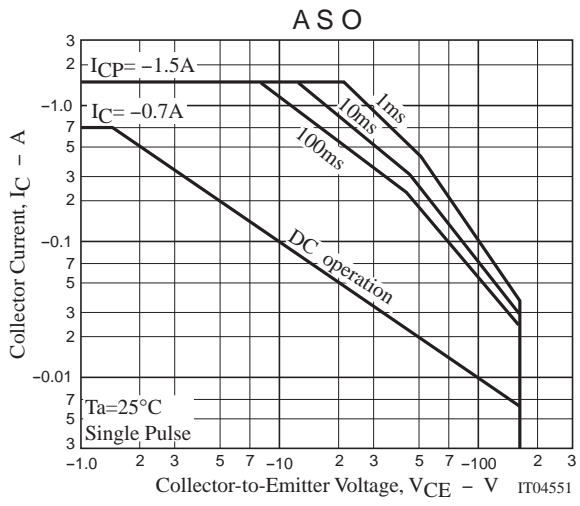


Ordering Information

Device	Package	Shipping	memo
2SA1768S-AN	NMP(Taping)	2,500pcs./box	Pb Free
2SA1768T-AN	NMP(Taping)	2,500pcs./box	



2SA1768



Bag Packing Specification

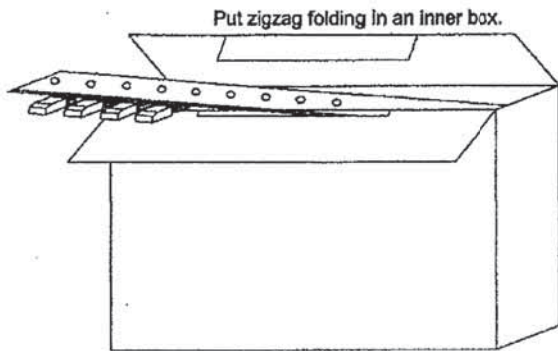
2SA1768S-AN, 2SA1768T-AN

NMP (Zigzag folding)

Storage package Outline name	Package type	Maximum Number of devices contained (pcs.)		Packing format	
		Inner box No.	Storage quantity	Outer box (C-6)	Outer box (C-8)
NMP	AN/AZ	C-3 Inner box Dimensions :mm(external) 330×45×125	2,500	8 inner boxes contained(20,000pcs.) Outer box Dimensions:mm(external) 585×345×195	4 inner boxes contained(10,000pcs.) Outer box Dimensions:mm(external) 345×300×195

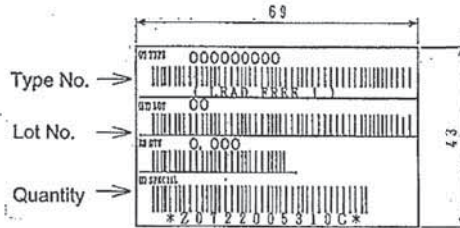
1. Packing format

Packing method



2. Bar code label

(Unit : mm)

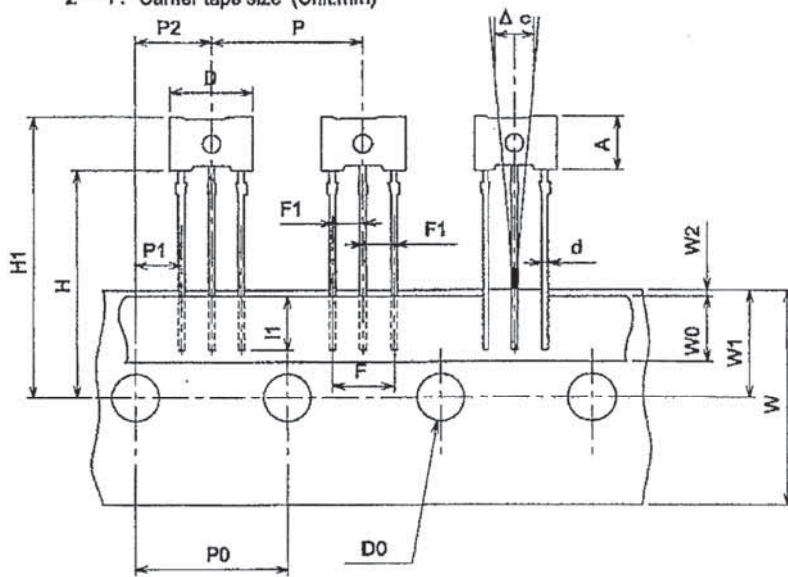


*LEAD FREE 1:

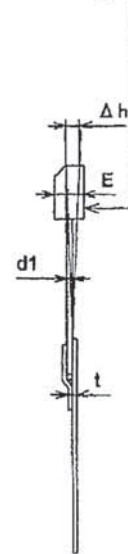
Lead-free External terminal surface treatment product.

2. Taping specifications

2-1. Carrier tape size (Unit:mm)



Marking surface



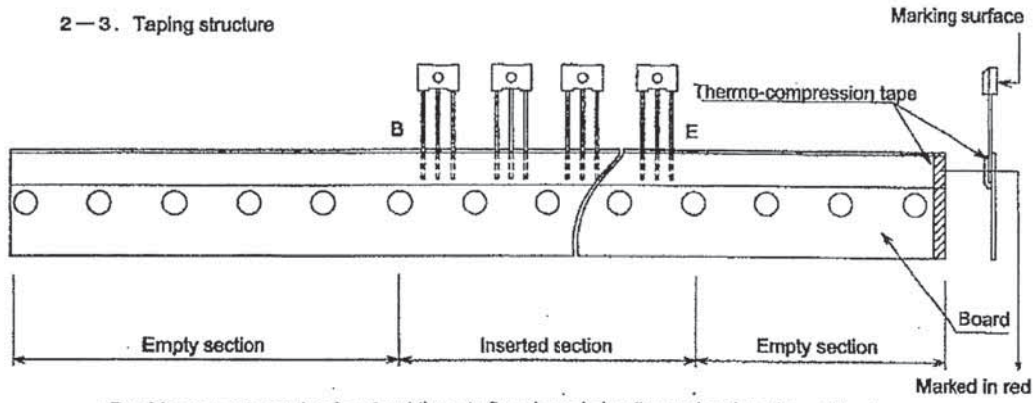
2-2. Taping size standard

Item	Symbol	Standard	Tolerance
Work piece outside diameter	D	6.9	±0.2
	E	2.5	±0.2
Work piece height	A	4.5	±0.2
Lead wire diameter	d	0.5	±0.1
Lead wire thickness	d1	0.45	±0.1
Bonded lead wire	I1	3.0MIN	
Pitch between products	P	12.7	±0.5
Pitch between perforations	P0	12.7	±0.2
Total pitch for 21 perforations	P0×20	254.0	±1.0
Distance between lead wire	F	5.0	+0.8 -0.2
Lead wire pitch distance	F1	2.54	+0.4 -0.1
Displacement of perforations	P1	3.81	±0.3
	P2	6.35	±0.3
Displacement of tape	W2	0~0.5	

Unit:mm

Item	Symbol	Standard	Tolerance
Tape width	W	18.0	±0.5
Adhesive tape	W0	6.0	±0.5
Displacement of perforations	W1	9.0	±0.5
Work piece bottom surface position	H	19.0	+1.0 -0.5
Work piece upper limit position	H1	23.5	±1.0
Perforations diameter	D0	φ4.0	±0.2
Tape thickness (total thickness)	t	0.6	±0.2
Product inclination	Δc	0	±0.7
Product inclination	Δh	0	±1.0

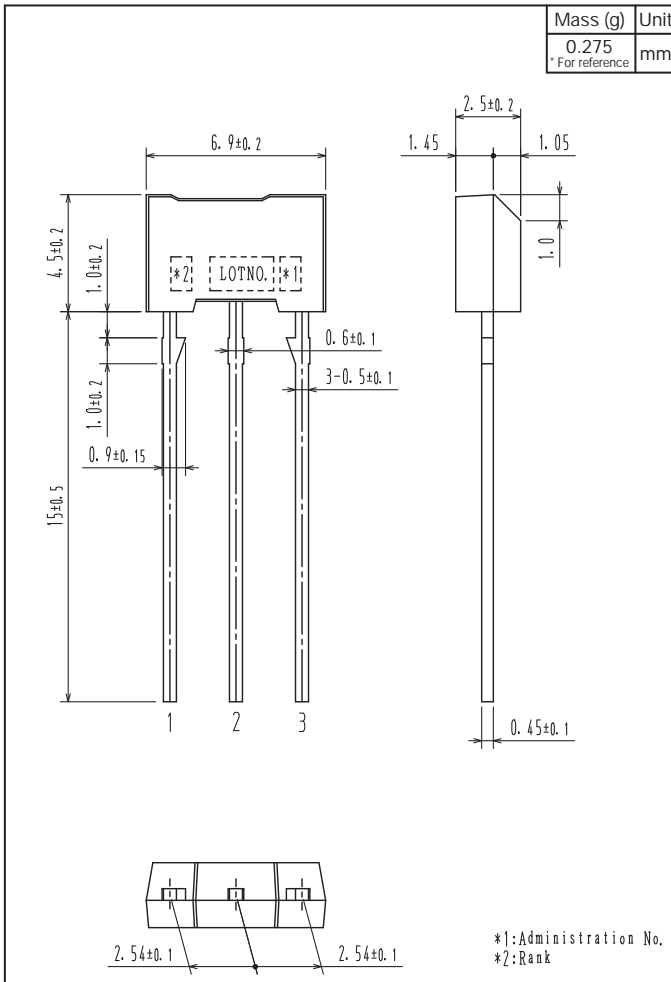
2—3. Taping structure



- Provide an empty section for about three to five pieces in leading and end portions of the tape.
- Provide an empty section in the fold-back portion.
- Provide marking in red to the E-side end of the board.

Outline Drawing

2SA1768S-AN, 2SA1768T-AN



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